300 Watt, SOT-23 Low Capacitance TVS for High Speed Line Protections

This new family of TVS offers transient overvoltage protection with significantly reduced capacitance. The capacitance is lowered by integrating a compensating diode in series. This integrated solution offers ESD protection for high speed interfaces such as communication systems, computers, and computer peripherals.

Features

- TVS Diode in Series with a Compensating Diode Offers <5 pF Capacitance
- ESD Protection Meeting IEC 61000-4-2, 4-4, 4-5
- Peak Power Rating of 300 W, 8 × 20 μs
- Bi-Direction Protection Can Be Achieved By Using Two Devices
- Flammability Rating UL 94 V-0
- Pb-Free Packages are Available

Mechanical Characteristics:

CASE: Void-free, transfer-molded, thermosetting plastic case

FINISH: Corrosion resistant finish, easily solderable

MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES

260°C for 10 Seconds

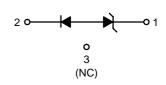
Package designed for optimal automated board assembly Small package size for high density applications Available in 8 mm Tape and Reel

Use the Device Number to order the 7 inch/3,000 unit reel. Replace the "T1" with "T3" in the Device Number to order the 13 inch/10,000 unit reel.



ON Semiconductor®

http://onsemi.com





SOT-23 (TO-236) CASE 318 STYLE 26

Lxx = Device Code xx = 05, 15, or 24 $M = Date Code^*$

MARKING

= Date Code
 = Pb-Free Package
 (Note: Microdot may be in either location)

*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|---------|---------------------|-----------------------|
| SL05T1 | SOT-23 | 3000/Tape & Reel |
| SL05T1G | SOT-23 (Pb-Free) | 3000/Tape & Reel |
| SL15T1 | SOT-23 | 3000/Tape & Reel |
| SL15T1G | SOT-23 (Pb-Free) | 3000/Tape & Reel |
| SL24T1 | SOT-23 | 3000/Tape & Reel |
| SL24T1G | SOT-23 (Pb-Free) | 3000/Tape & Reel |
| SL05T3 | SOT-23 | 10,000/Tape & Reel |
| SL15T3 | SOT-23 | 10,000/Tape & Reel |
| SL24T3 | SOT-23 | 10,000/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

DEVICE MARKING INFORMATION

See specific marking information in the device marking column of the table on page 3 of this data sheet.

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|-----------------------------------|-----------------------|--------------------|
| Peak Power Dissipation @ 8x20 usec (Note 1) @ T _L ≤ 25°C | P _{pk} | 300 | W |
| IEC 61000–4–2 Level 4 Contact Discharge Air Discharge IEC 61000–4–4 EFT IEC 61000–4–5 Lightning | V _{pp} | ±8 ±16 40 12 | kV kV A A |
| Total Power Dissipation on FR–5 Board (Note 2) @ T _A = 25°C Derate above 25°C | P _D | 225 1.8 | mW mW/°C |
| Thermal Resistance Junction to Ambient | $R_{	heta JA}$ | 556 | °C/W |
| Total Power Dissipation on Alumina Substrate (Note 3) @ T _A = 25°C Derate above 25°C | P _D | 300 2.4 | mW mW/°C |
| Thermal Resistance Junction-to-Ambient | $R_{	heta JA}$ | 417 | °C/W |
| Junction and Storage Temperature Range | T _J , T _{stg} | - 55 to +150 | °C |
| Lead Solder Temperature – Maximum (10 Second Duration) | T_L | 260 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

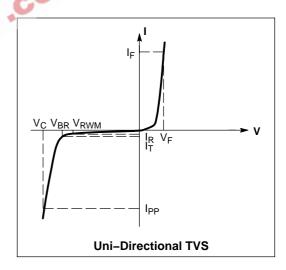
1. Non-repetitive current pulse per Figure 2
2. FR-5 = 1.0 x 0.75 x 0.62 in.
3. Alumina = 0.4 x 0.3 x 0.024 in., 99.5% alumina

ELECTRICAL CHARACTERISTICS

(T_A = 25°C unless otherwise noted)

UNIDIRECTIONAL (Circuit tied to Pins 1 and 3 or 2 and 3)

| Symbol | Parameter | | | | |
|---|--|--|--|--|--|
| I _{PP} | Maximum Reverse Peak Pulse Current | | | | |
| V _C | Clamping Voltage @ I _{PP} | | | | |
| V _{RWM} | Working Peak Reverse Voltage | | | | |
| I _R Maximum Reverse Leakage Current @ V _R | | | | | |
| V _{BR} | Breakdown Voltage @ I _T | | | | |
| I _T | Test Current | | | | |
| ΘV _{BR} | Maximum Temperature Coefficient of V _{BR} | | | | |
| I _F | Forward Current | | | | |
| V _F | Forward Voltage @ I _F | | | | |
| Z _{ZT} | Maximum Zener Impedance @ I _{ZT} | | | | |
| I _{ZK} | Reverse Current | | | | |
| Z _{ZK} | Maximum Zener Impedance @ I _{ZK} | | | | |



ELECTRICAL CHARACTERISTICS

| | | | | Breakdown Voltage (Note 4) | | V _C , Clampi (Not | | Max | Сарас | itance |
|--------|---------|------------------|-----------------------------------|--------------------------------|------|---------------------------------|-------|-----------------|-------------------------|-------------------|
| | Device | V _{RWM} | I _R @ V _{RWM} | V _{BR} @ 1 mA (Volts) | | @ 1 A | @ 5 A | I _{PP} | @ V _R = 0 V, | 1 MHz (pF) |
| Device | Marking | (V) | (μΑ) | Min | Max | (V) | (V) | (A) | Тур | Max |
| SL05 | L05 | 5.0 | 20 | 6.0 | 8.0 | 9.8 | 11 | 17 | 3.5 | 5.0 |
| SL15 | L15 | 15 | 1.0 | 16.7 | 18.5 | 24 | 30 | 10 | 3.5 | 5.0 |
| SL24 | L24 | 24 | 1.0 | 26.7 | 29 | 43 | 55 | 5.0 | 3.5 | 5.0 |

- 4. V_{BR} measured at pulse test current of 1 mA at an ambient temperature of 25°C
- Surge current waveform per Figure 2

C, CAPACITANCE (pF), 1 MHz FREQ.

3.5 3

2.5

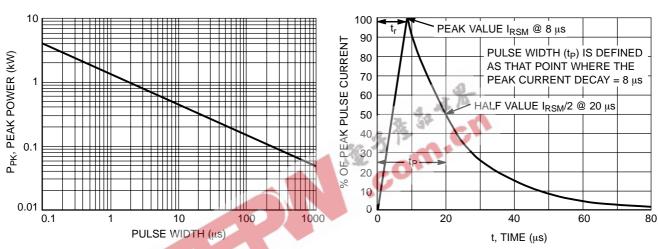
2

1.5

0.5 0

@ ZERO BIAS

TYPICAL CHARACTERISTICS



SL05

SL15

SL24

@ V_{RWM}

Figure 1. Maximum Peak Power Rating

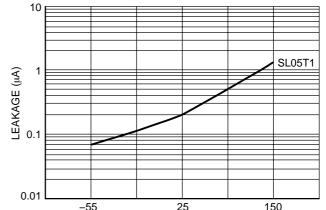


Figure 2. $8\times 20~\mu s$ Pulse Waveform

Figure 3. Typical Junction Capacitance

@ 50% V_{RWM}

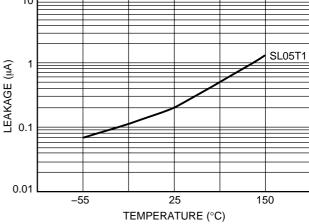


Figure 4. Typical Leakage Over Temperature

Applications Background

This new family of TVS devices (SL05T1 series) are designed to protect sensitive electronics such as communications systems, computers, and computer peripherals against damage due to ESD conditions or transient voltage conditions. Because of their low capacitance value (less than 5 pF), they can be used in high speed I/O data lines. Low capacitance is achieved by integrating a compensating diode in series with the TVS which is basically based in the below theoretical principle:

- Capacitance in parallel: CT = C1+C2+....+Cn
- Capacitance in series: 1/CT = (1/C1)+(1/C2)+....+(1/Cn) The Figure 5 shows the integrated solution of the SL05T1 series device:



Figure 5.

In the case that an over–voltage condition occurs in the I/O line protected by the SL05T1 series device, the TVS is reversed–biased while the compensation diode is forward–biased so the resulting current due to the transient voltage is drained to ground.

If protection in both polarities is required, an additional device is connected in inverse—parallel with reference to the first one, the Figure 6 illustrates the inverse—parallel connection for bi—directional or unidirectional lines:

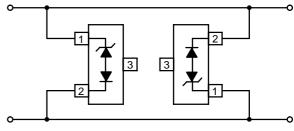


Figure 6.

An alternative solution to protect unidirectional lines, is to connect a fast switching steering diode in parallel with the SL05T1 series device. When the steering diode is forward–biased, the TVS will avalanche and conduct in reverse direction. It is important to note that by adding a steering diode, the effective capacitance in the circuit will be increased, therefore the impact of adding a steering diode must be taken in consideration to establish whether the incremental capacitance will affect the circuit functionality or not. The Figure 7 shows the connection between the steering diode and the SL05T1 series device:

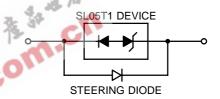


Figure 7.

Another typical application in which the SL05T1 series device can be utilized, is to protect multiple I/O lines. The protection in each of the I/O lines is achieved by connecting two devices in inverse—parallel. The Figure 8 illustrates how multiple I/O line protection is achieved:

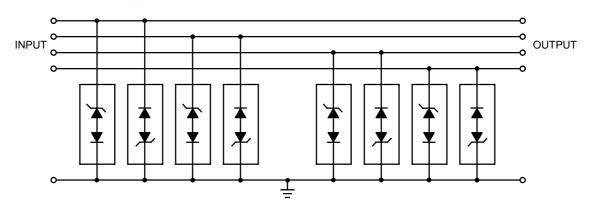
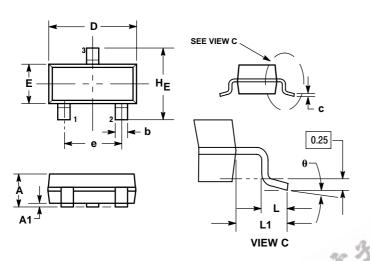


Figure 8.

For optimizing the protection, it is recommended to use ground planes and short path lengths to minimize the PCB's ground inductance.

PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AN**



- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: INCH.

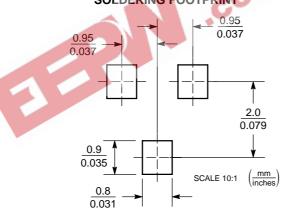
 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF
- BASE MATERIAL. 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08.

| | М | ILLIMETE | RS | INCHES | | | |
|-----|------|----------|------|--------|-------|-------|--|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX | |
| Α | 0.89 | 1.00 | 1.11 | 0.035 | 0.040 | 0.044 | |
| A1 | 0.01 | 0.06 | 0.10 | 0.001 | 0.002 | 0.004 | |
| b | 0.37 | 0.44 | 0.50 | 0.015 | 0.018 | 0.020 | |
| С | 0.09 | 0.13 | 0.18 | 0.003 | 0.005 | 0.007 | |
| D | 2.80 | 2.90 | 3.04 | 0.110 | 0.114 | 0.120 | |
| E | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 | |
| е | 1.78 | 1.90 | 2.04 | 0.070 | 0.075 | 0.081 | |
| L | 0.10 | 0.20 | 0.30 | 0.004 | 0.008 | 0.012 | |
| L1 | 0.35 | 0.54 | 0.69 | 0.014 | 0.021 | 0.029 | |
| HE | 2.10 | 2.40 | 2.64 | 0.083 | 0.094 | 0.104 | |

CATHODE

ANODE NO CONNECTION

SOLDERING FOOTPRINT



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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